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1. Global joint venture starts operations as WeEn Semiconductors

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As from November 9th, 2015 NXP Semiconductors N.V. and Beijing JianGuang Asset Management Co. Ltd established Bipolar Power joint venture (JV), **WeEn Semiconductors**, which will be used in future Bipolar Power documents together with new contact details.

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Thank you for your cooperation and understanding,

WeEn Semiconductors





1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT186A (TO-220F) "full pack" plastic package intended for use in applications requiring high thermal cycling performance and high junction temperature capability ($T_{j(max)} = 150$ °C).

2. Features and benefits

- · High junction operating temperature capability
- High thermal cycling performance
- High voltage capability
- Planar passivated for voltage ruggedness and reliability

3. Applications

- Ignition circuits
- Motor control
- Protection circuits e.g. SMPS inrush current
- Voltage regulation

4. Quick reference data

Table	1.	Quick	reference	data
IUDIC		Quich		uutu

Symbol	Parameter	Conditions	Mi	n Typ	Max	Unit
V _{DRM}	repetitive peak off- state voltage		-	-	600	V
V _{RRM}	repetitive peak reverse voltage		-	-	600	V
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u>	-	-	180	A
		half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms	-	-	198	A
Tj	junction temperature		-	-	150	°C
I _{T(AV)}	average on-state current	half sine wave; T _h ≤ 81 °C; <u>Fig. 1</u>	-	-	10.2	A
I _{T(RMS)}	RMS on-state current	half sine wave; T _h ≤ 81 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	-	16	A
Static chara	acteristics		· · ·	· · · ·	·	
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	-	-	15	mA
Dynamic ch	naracteristics					

SCR

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
dV _D /dt		V_{DM} = 402 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs

5. Pinning information

Table 2	. Pinning in	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	А -Ң К
2	А	anode		G sym037
3	G	gate		Symosi
mb	n.c.	mounting base; isolated		
			TO-220F (SOT186A)	

6. Ordering information

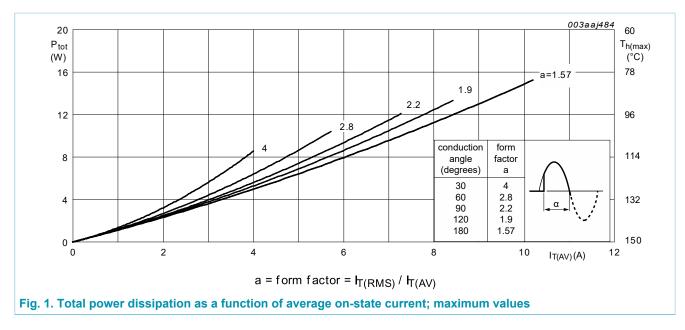
Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
TYN16X-600CT	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"	SOT186A			

7. Limiting values

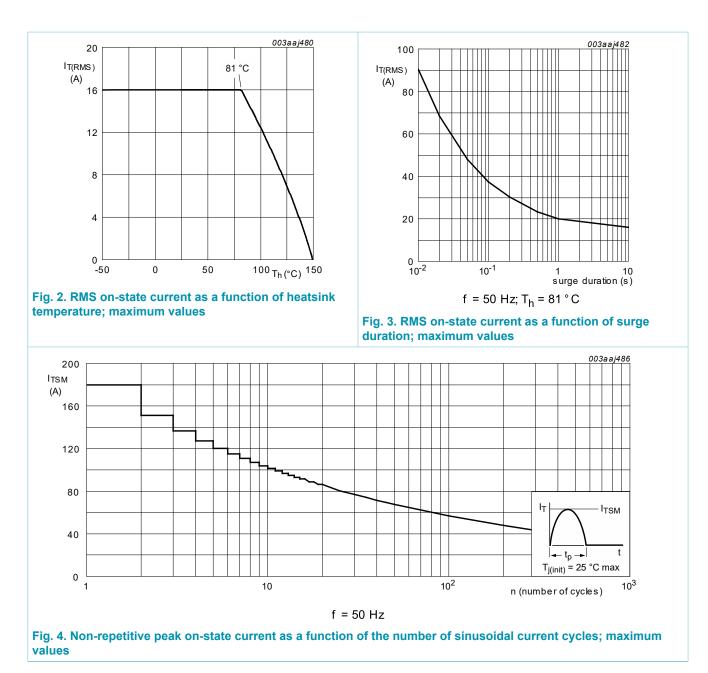
Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	600	V
V _{RRM}	repetitive peak reverse voltage		-	600	V
I _{T(AV)}	average on-state current	half sine wave; T _h ≤ 81 °C; <u>Fig. 1</u>	-	10.2	А
I _{T(RMS)}	RMS on-state current	half sine wave; $T_h \le 81 \text{ °C}$; Fig. 2; Fig. 3	-	16	А
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	180	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	-	198	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	162	A²s
dl _T /dt	rate of rise of on-state current	I_T = 40 A; I_G = 200 mA; dI_G/dt = 200 mA/ µs	-	50	A/µs
I _{GM}	peak gate current		-	4	А
V _{RGM}	peak reverse gate voltage		-	5	V
P _{GM}	peak gate power		-	10	W
P _{G(AV)}	average gate power	over any 20 ms period	-	1	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C

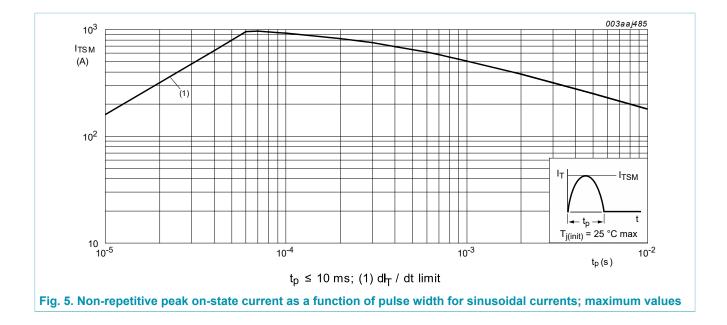


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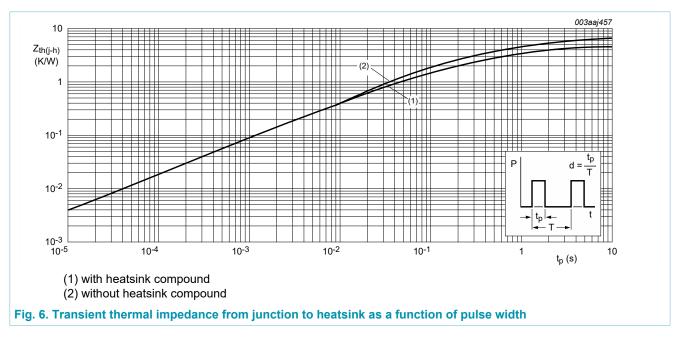
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TYN16X-600CT

8. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance	with heatsink compound; Fig. 6	-	-	4.5	K/W
	from junction to heatsink	without heatsink compound; Fig. 6	-	-	6.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



9. Isolation characteristics

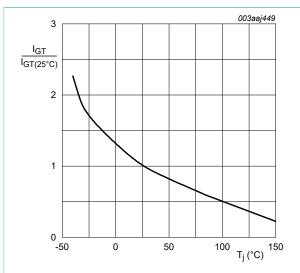
Table 6. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _h = 25 °C	-	-	2500	V
C _{isol}	isolation capacitance	from anode to external heatsink; f = 1 MHz; T _h = 25 °C	-	10	-	pF

TYN16X-600CT

10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	-	-	15	mA
۱ _L	latching current	V_D = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>	-	-	60	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	40	mA
V _T	on-state voltage	I _T = 32 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.6	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11	-	0.7	1.3	V
		V _D = 400 V; I _T = 0.1 A; T _j = 150 °C; Fig. 11	0.2	0.4	-	V
I _D	off-state current	V _D = 600 V; T _j = 150 °C	-	0.2	1	mA
I _R	reverse current	V _R = 600 V; T _j = 150 °C	-	0.2	1	mA
Dynamic ch	aracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 40 A; V _D = 600 V; I _G = 100 mA; dI _G /dt = 5 A/µs; T _j = 25 °C	-	2	-	μs
t _q	commutated turn-off time		-	70	-	μs





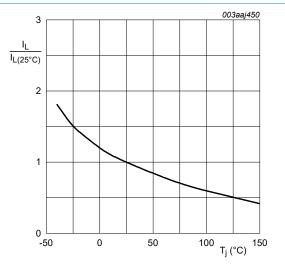
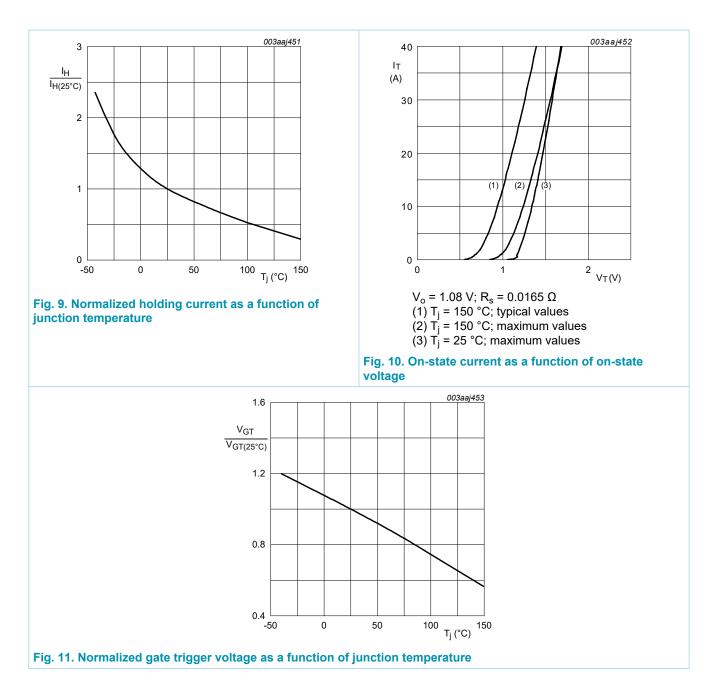


Fig. 8. Normalized latching current as a function of junction temperature

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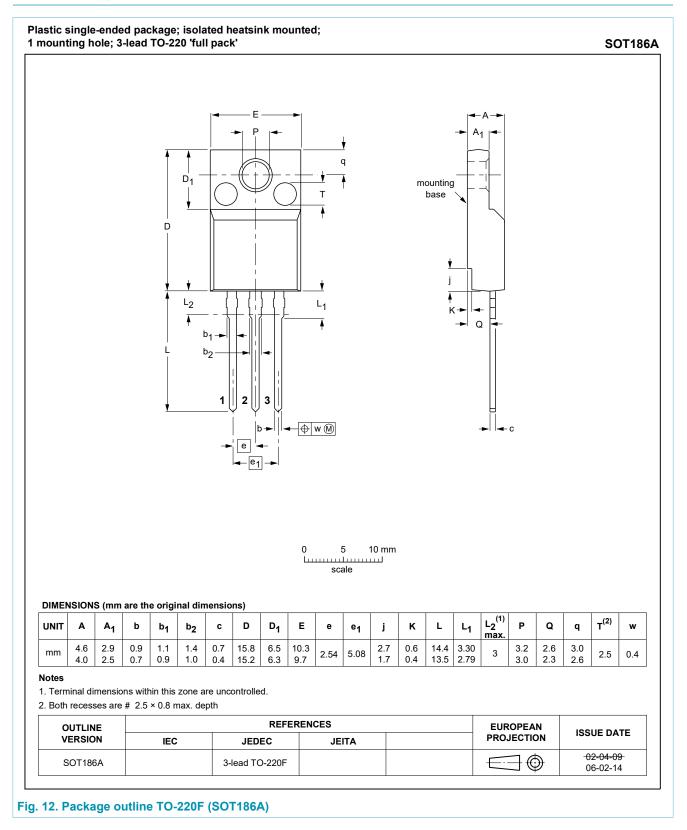
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11. Package outline



TYN16X-600CT

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12. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.ween-semi.com</u>.

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TYN16X-600CT

13. Contents

1.	General description	.1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	.1
5.	Pinning information	.2
6.	Ordering information	.2
7.	Limiting values	3
8.	Thermal characteristics	6
9.	Isolation characteristics	.6
10.	Characteristics	.7
11.	Package outline	9
12.	Legal information1	0

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